# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



ALPH SEMIC	<b>IA &amp; OM</b> CONDUG	<b>(EGA</b> CTOR		AO3407 30V P-Channel MOSFET				
General Descrip			Product Summary					
The AO3407 uses an excellent R <sub>DS(ON)</sub> with suitable for use as a	arge. This de	vice is	$V_{DS}$ $I_D$ (at $V_{GS}$ = -10V) $R_{DS(ON)}$ (at $V_{GS}$ = -10V) $R_{DS(ON)}$ (at $V_{GS}$ = -4.5V)		-30V -4.1A < 52mΩ < 87mΩ			
D	Top View	DT23 Bottom Vi	G G		G G S			
Absolute Maximum R	atings T <sub>A</sub> =2	5°C unless						
Parameter			Symbol	-30		Units V		
Drain-Source Voltage			V <sub>DS</sub>					
Gate-Source Voltage   Continuous Drain T <sub>A</sub> =25°C   Current T <sub>A</sub> =70°C			V <sub>GS</sub> -I <sub>D</sub>	+20 -4.1 -3.5		A		
Pulsed Drain Current <sup>C</sup>			I <sub>DM</sub>	-25				
Power Dissipation <sup>B</sup> $T_A=25^{\circ}C$			-P <sub>D</sub>	<u> </u>		— w		
Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>STG</sub>	-55 to 150		°C		
Thermal Characterist			Symbol	Turn	Мах	Units		
Parameter Maximum Junction-to-Ambient <sup>A</sup> t ≤ 10s			Symbol	<b>Typ</b>				
		R <sub>0JA</sub>	70	90	°C/W			
Maximum Junction-to-		Steady-State		100	125	°C/W		

Maximum Junction-to-Lead

 $R_{\theta JL}$ 

Steady-State

63

80

°C/W



#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC P	PARAMETERS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage			-30			V
I <sub>DSS</sub> Z	Zara Cata Valtaga Drain Current	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C				-1	μΑ
	Zero Gate Voltage Drain Current					-5	
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ = ±20V				±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS}$ I <sub>D</sub> =-250µA		-1.4	-1.9	-2.4	V
I <sub>D(ON)</sub>	On state drain current	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-5V		-25			Α
R <sub>DS(ON)</sub>		V <sub>GS</sub> =-10V, I <sub>D</sub> =-4.1A			34	52	mΩ
	Static Drain-Source On-Resistance		T <sub>J</sub> =125°C		52	73	
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3A			54	87	mΩ
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-4.1A			10		S
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =-1A,V <sub>GS</sub> =0V			-0.7	-1	V
I <sub>S</sub>	Maximum Body-Diode Continuous Current						Α
DYNAMIC	PARAMETERS						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =-15V, f=1MHz			520		pF
C <sub>oss</sub>	Output Capacitance				100		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				65		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		3.5	7.5	11.5	Ω
SWITCHI	NG PARAMETERS						
Q <sub>g</sub> (10V)	Total Gate Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-4.1A			9.2	11	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge				4.6	6	nC
Q <sub>gs</sub>	Gate Source Charge				1.6		nC
Q <sub>gd</sub>	Gate Drain Charge				2.2		nC
t <sub>D(on)</sub>	Turn-On DelayTime				7.5		ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, R <sub>L</sub> =3.65Ω, R <sub>GEN</sub> =3Ω			5.5		ns
t <sub>D(off)</sub>	Turn-Off DelayTime				19		ns
t <sub>f</sub>	Turn-Off Fall Time				7		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time I <sub>F</sub> =-4.1A, dl/dt=100A/µs		/μs		11		ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =-4.1A, dl/dt=100A		5.3		nC	

A. The value of R<sub>8JA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> =25° C. The

value in any given application depends on the user's specific board design. B. The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150^{\circ}$  C, using  $\leq 10$  s junction-to-ambient thermal resistance. C. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}=150^{\circ}$  C. Ratings are based on low frequency and duty cycles to keep initialT<sub>1</sub>=25° C.

D. The  $R_{\theta JA}$  is the sum of the thermal impedence from junction to lead  $R_{\theta JL}$  and lead to ambient.

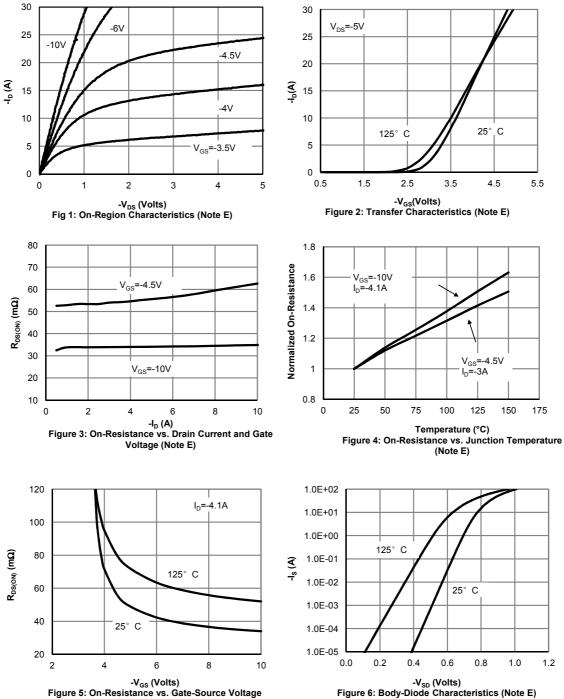
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on  $1n^2$  FR-4 board with 20z. Copper, assuming a maximum junction temperature of  $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.

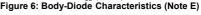
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### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

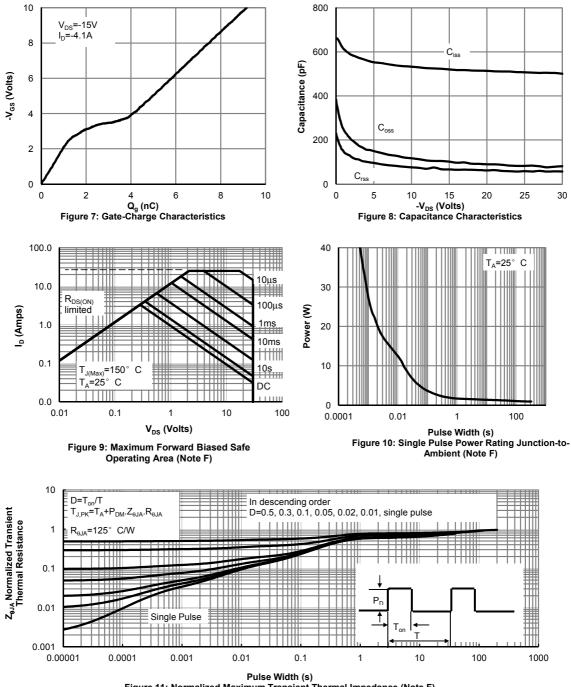


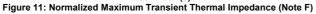
(Note E)





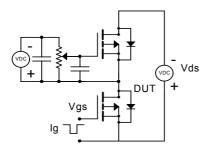
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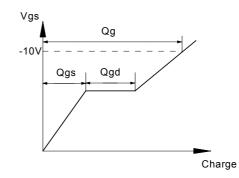




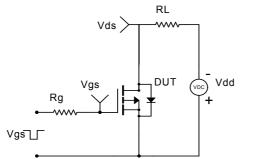


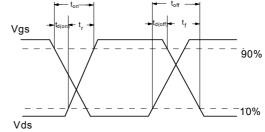
### Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





### Diode Recovery Test Circuit & Waveforms

